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-2012: (5) wafer with transfer with manual\$2 with automatic\$4

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-2012: (1) wafer with automatic\$7

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-2012: (4) wafer with automatic\$7

-2012: (5) wafer with automatic\$7

-2012: (6) wafer with automatic\$7

-2012: (7) wafer with automatic\$7

-2012: (7) wafer with automatic\$7

-2012: (8) wafer with automat 9/2005 SN 10/080,914 EPO, JPO, IBM TDB ID Issue Date Pages JP 61256620 A 19861114 JP 58194348 A 19831112 19830404 WO 9910915 A1 19990304 JP 58056330 A メ Hita 〇 Detaits 12 HTML -O Drafts -O Pending 9-**A** Active